

AMENDMENTS TO THE SPECIFICATION

Please amend the first paragraph of page 1 as follows:

This is a divisional application of Application Serial No. 10/219,212 filed on August 15, 2002, now U.S. Patent No. 6,864,581 issued on March 8, 2005. The present invention is related to Application Serial No. 10/727,451 filed on December 3, 2003 for "Method of Forming a Dual Damascene Metal Trace with Reduced RF Impedance Resulting from the Skin Effect" by Peter J. Hopper et al., Application Serial No. 10/820,476 filed on April 8, 2004 for "Method of Forming a Metal Trace with Reduced RF Impedance Resulting from the Skin Effect" by Peter J. Hopper et al., and Application Serial No. 11/013,490 filed on December 15, 2004 for "Method of Forming a Conductive Trace with Reduced RF Impedance Resulting from the Skin Effect" by Peter J. Hopper et al.